

APTB1612SGYC

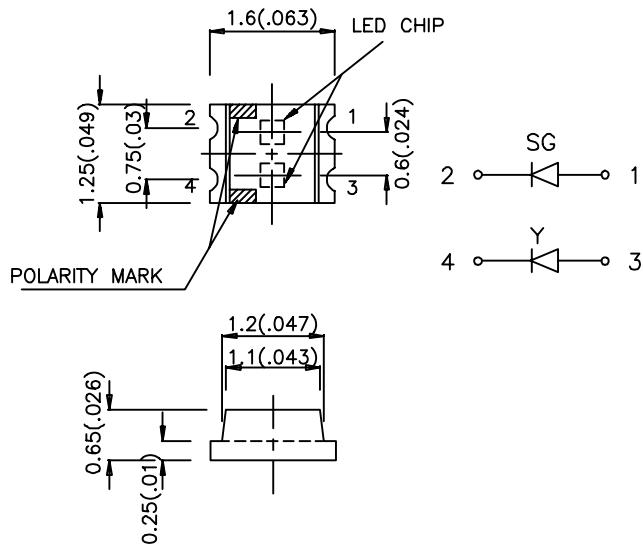
Features

- 1.6mmx1.2mm SMT LED, 0.65mm THICKNESS.
- BI-COLOR,LOW POWER CONSUMPTION.
- WIDE VIEWING ANGLE.
- IDEAL FOR BACKLIGHT AND INDICATOR.
- VARIOUS COLORS AND LENS TYPES AVAILABLE.
- PACKAGE :2000PCS/ REEL.

Description

The Super Bright Green source color devices are made with Gallium Phosphide Green Light Emitting Diode. The Yellow source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Yellow Light Emitting Diode.

Package Dimensions



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.2(0.0079")$ unless otherwise noted.
3. Lead spacing is measured where the lead emerge package.
4. Specifications are subjected to change without notice.

Selection Guide

Part No.	Dice	Lens Type	I _v (mcd) @ 20 mA		Viewing Angle
			Min.	Typ.	
APTB1612SGYC	SUPER BRIGHT GREEN (GaP)	WATER CLEAR	3	12	120°
	YELLOW (GaAsP/GaP)		3	8	

Note:

1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

Electrical / Optical Characteristics at T_A=25°C

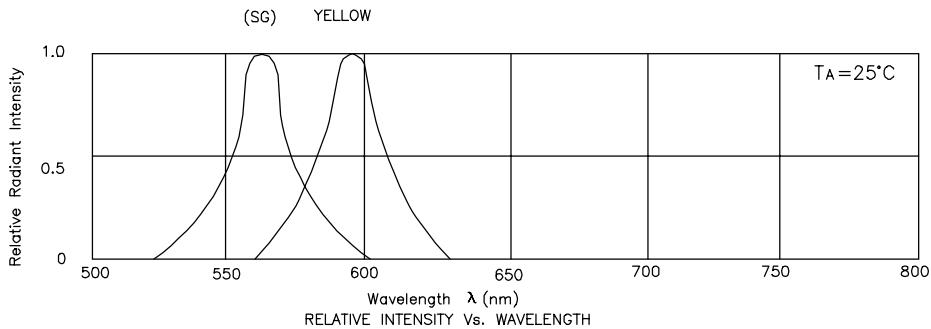
Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λ _{peak}	Peak Wavelength	Super Bright Green Yellow	565 590		nm	IF=20mA
λ D	Dominate Wavelength	Super Bright Green Yellow	568 588		nm	IF=20mA
Δλ1/2	Spectral Line Halfwidth	Super Bright Green Yellow	30 35		nm	IF=20mA
C	Capacitance	Super Bright Green Yellow	15 20		pF	VF=0V;f=1MHz
V _F	Forward Voltage	Super Bright Green Yellow	2.2 2.1	2.5 2.5	V	IF=20mA
I _R	Reverse Current	All		10	uA	VR = 5V

Absolute Maximum Ratings at T_A=25°C

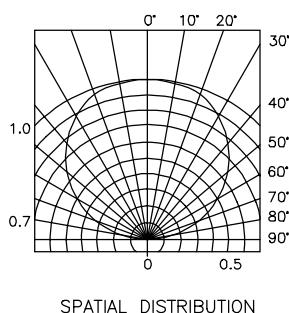
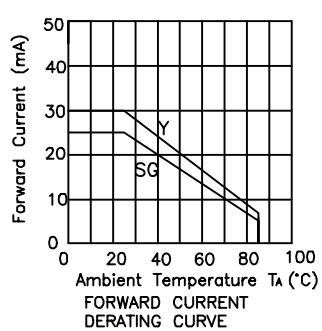
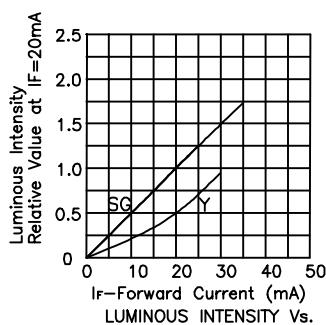
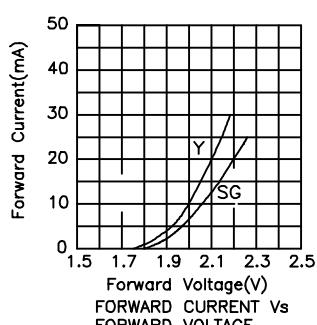
Parameter	Super Bright Green	Yellow	Units
Power dissipation	105	105	mW
DC Forward Current	25	30	mA
Peak Forward Current [1]	140	140	mA
Reverse Voltage	5	5	V
Operation/Storage Temperature	-40°C To +85°C		

Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

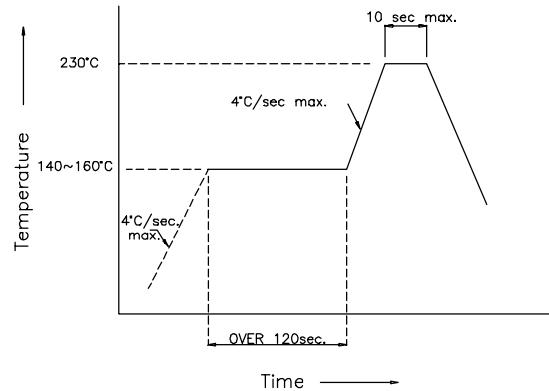


Super Bright Green / Yellow APTB1612SGYC

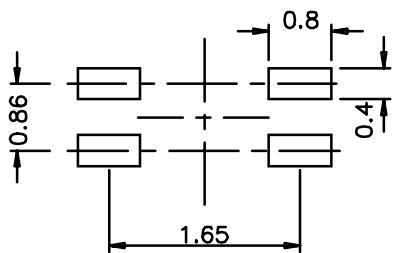


APTB1612SGYC SMT Reflow Soldering Instructions

Number of reflow process shall be less than 2 times and cooling process to normal temperature is required between first and second soldering process."



APTB1612SGYC Recommended Soldering Pattern (Units : mm)



APTB1612SGYC Tape Specifications
(Units : mm)

